

### Typical Applications

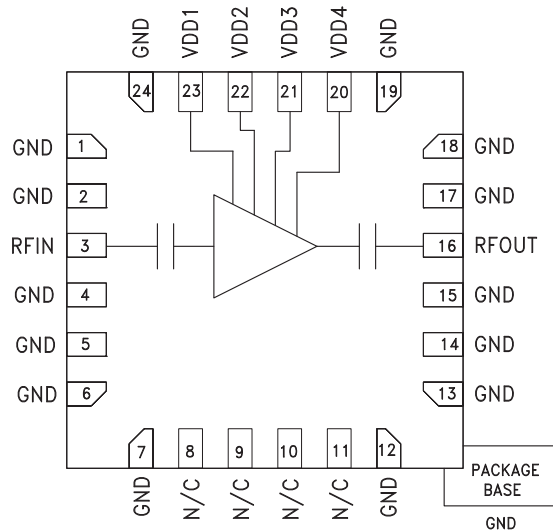
The HMC566LP4E is ideal for:

- Point-to-Point Radios
- Point-to-Multi-Point Radios & VSAT
- Test Equipment and Sensors
- Military & Space

### Features

- Low Noise Figure: 2.8 dB
- High Gain: 21 dB
- High OIP3: +24 dBm
- Single Positive Supply: +3V @ 82 mA
- 50 Ohm Matched & DC Blocked I/Os
- 24 Lead 4x4mm QFN Package: 16mm<sup>2</sup>

### Functional Diagram



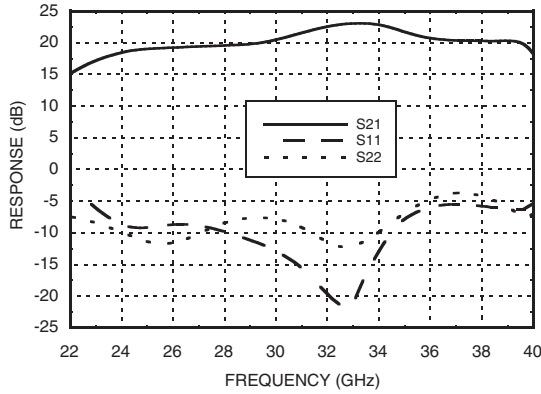
### General Description

The HMC566LP4E is a high dynamic range GaAs pHEMT MMIC Low Noise Amplifier (LNA) in a 4x4 mm SMT package which operates from 28 to 36 GHz. The HMC566LP4E provides 21 dB of small signal gain, 2.8 dB of noise figure and output IP3 of 24 dBm. This self-biased LNA is ideal for hybrid and MCM assemblies due to its compact size, single +3V supply operation, and DC blocked RF I/O's. The RoHS packaged HMC566LP4E eliminates the need for wirebonding and allows the use of high volume surface mount manufacturing techniques. The HMC566LP4E is also available in chip form as the HMC566.

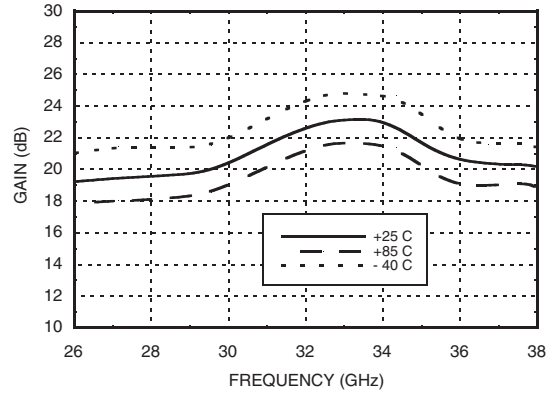
### Electrical Specifications, $T_A = +25^\circ\text{C}$ , $V_{dd\ 1, 2, 3, 4} = +3\text{V}$

Parameter	Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	Units
Frequency Range	28 - 31.5			31.5 - 33.5			33.5 - 36			GHz
Gain	18	21		19.5	22.5		18	21		dB
Gain Variation Over Temperature		0.03			0.03			0.03		dB/ °C
Noise Figure		2.8	3.6		2.8	3.6		3.3	4.3	dB
Input Return Loss		14			18			12		dB
Output Return Loss		8			10			7		dB
Output Power for 1 dB Compression (P1dB)		11			12			11		dBm
Saturated Output Power (P <sub>sat</sub> )		13			14			13		dBm
Output Third Order Intercept (IP3)		23.5			24.5			24.5		dBm
Supply Current (I <sub>dd1</sub> +I <sub>dd2</sub> +I <sub>dd3</sub> +I <sub>dd4</sub> )	50	82	106	50	82	106	50	82	106	mA

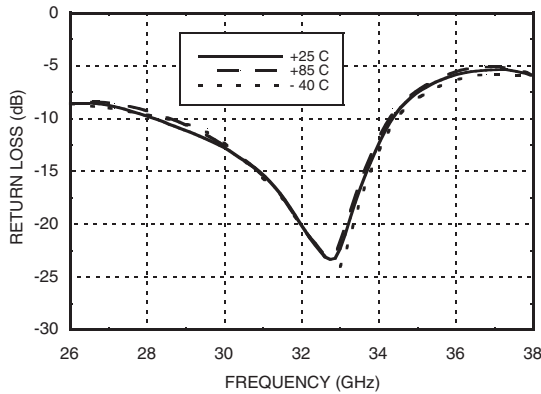
**Broadband Gain & Return Loss**



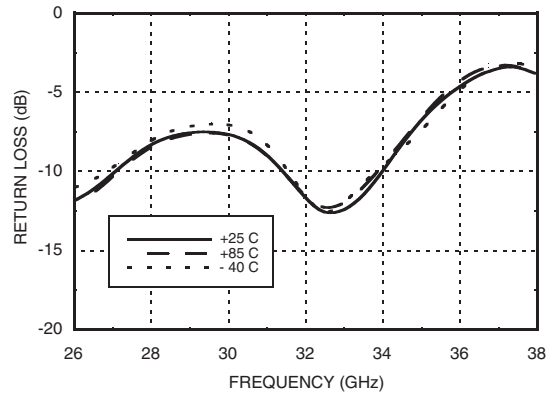
**Gain vs. Temperature**



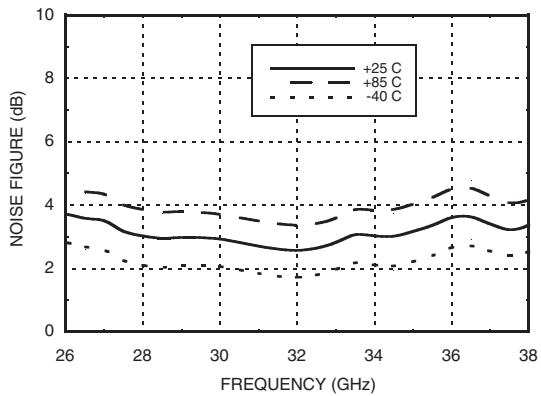
**Input Return Loss vs. Temperature**



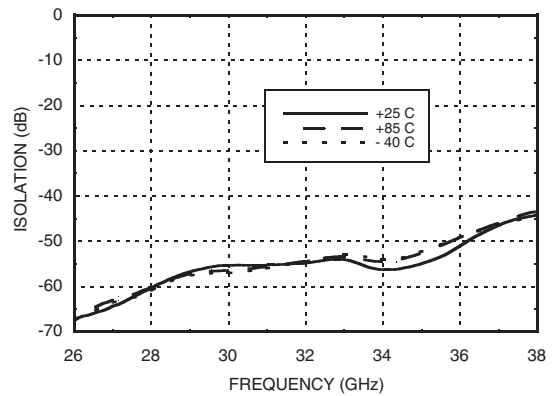
**Output Return Loss vs. Temperature**



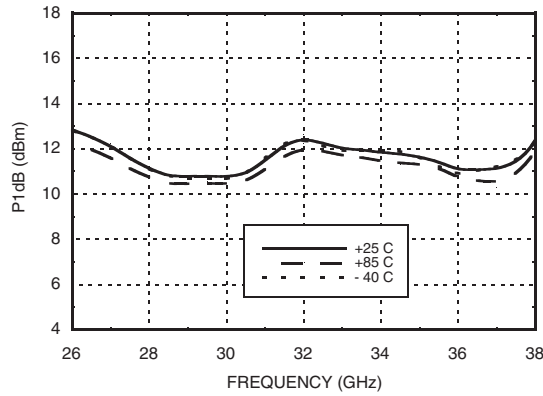
**Noise Figure vs. Temperature**



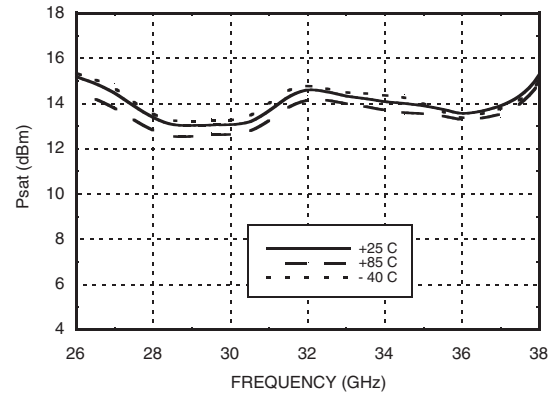
**Reverse Isolation vs. Temperature**



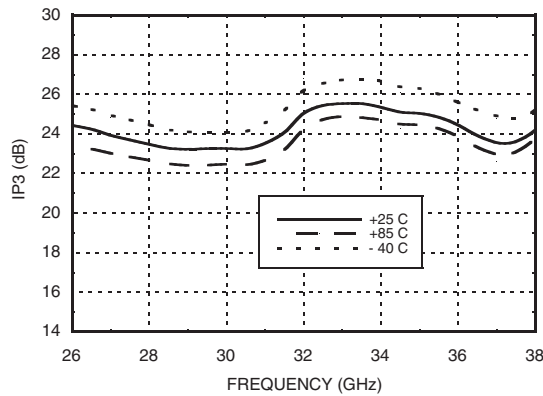
**P1dB vs. Temperature**



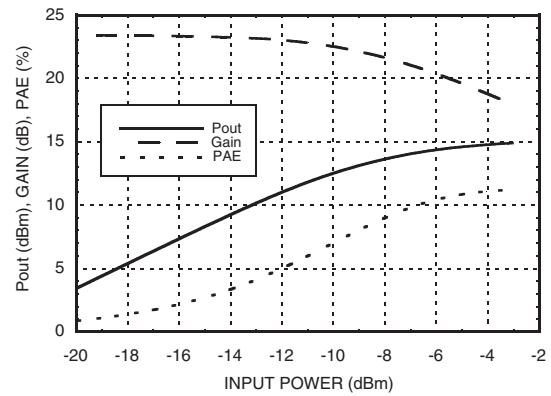
**Psat vs. Temperature**



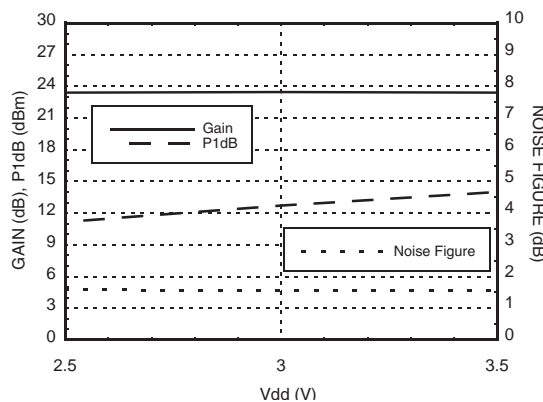
**Output IP3 vs. Temperature**



**Power Compression @ 32 GHz**



**Gain, Noise Figure & Power vs. Supply Voltage @ 32 GHz**



**Absolute Maximum Ratings**

Drain Bias Voltage (Vdd1, 2, 3, 4)	+3.5 V
RF Input Power (RFIN)(Vdd = +3 Vdc)	+5 dBm
Channel Temperature	175 °C
Continuous P <sub>diss</sub> (T= 85 °C) (derate 9.6 mW/°C above 85 °C)	0.8 W
Thermal Resistance (channel to ground paddle)	104 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C



**ELECTROSTATIC SENSITIVE DEVICE  
OBSERVE HANDLING PRECAUTIONS**


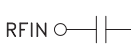
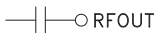



### Typical Supply Current vs. Vdd

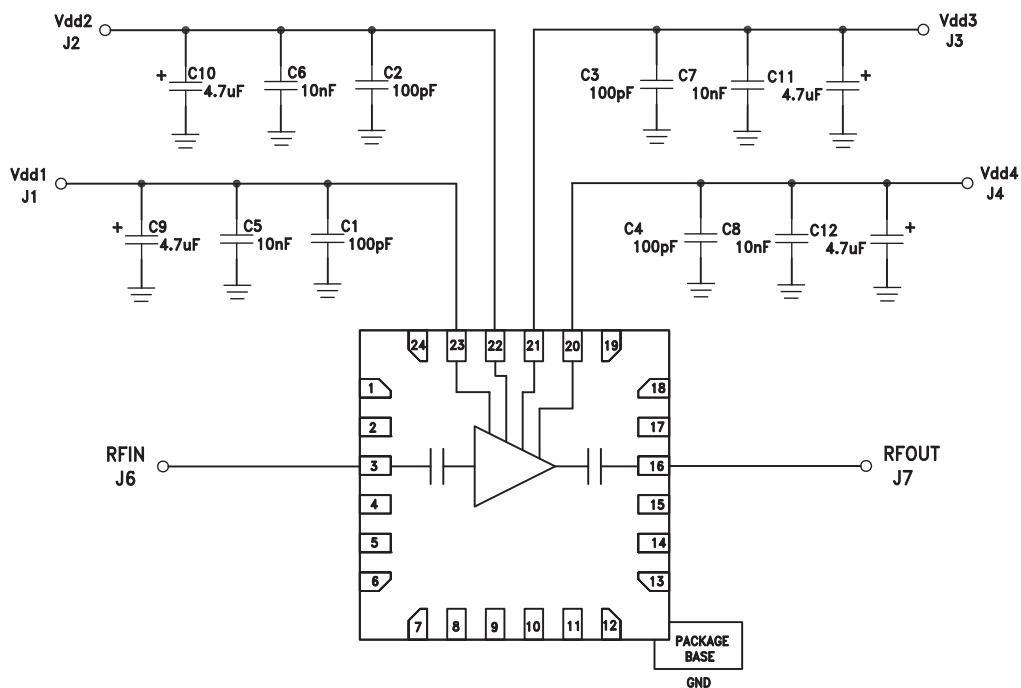
Vdd (V)	Idd (mA)
+2.5	79
+3.0	82
+3.5	85

Note: Amplifier will operate over full voltage ranges shown above.

### Pin Descriptions

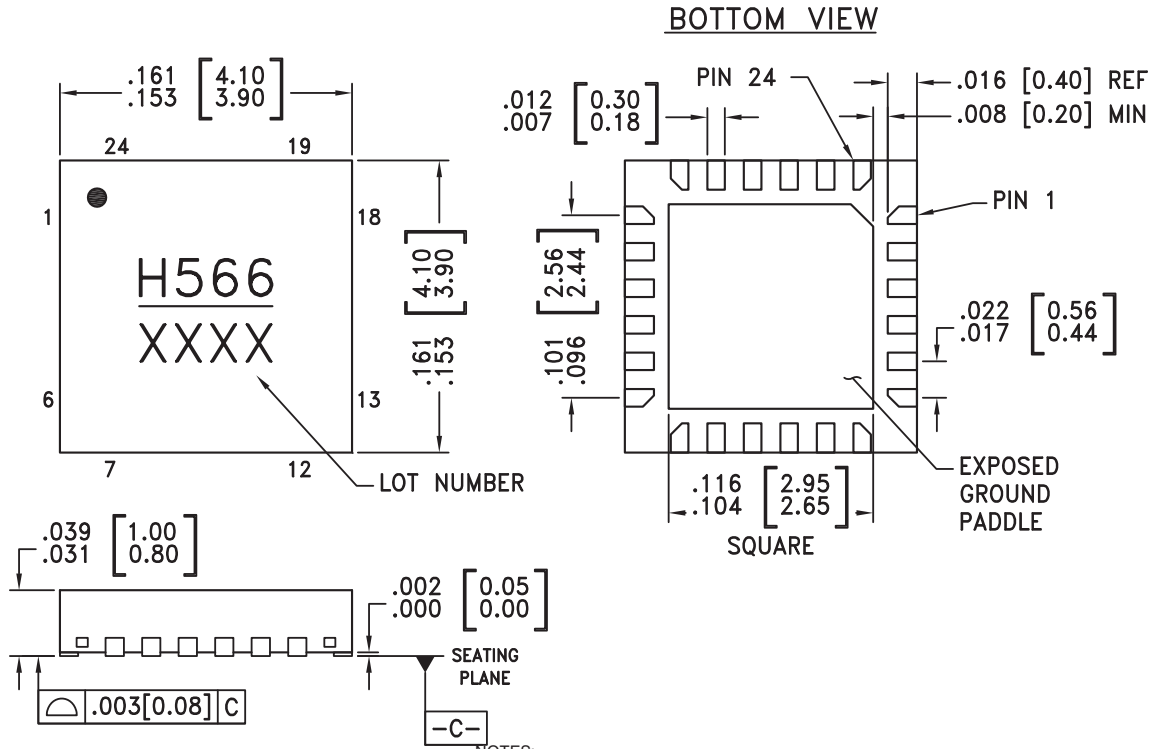
Pin Number	Function	Description	Interface Schematic
1, 2, 4 - 7, 12 - 15, 17 - 19, 24	GND	This pins and exposed ground paddle must be connected to RF/DC ground.	
3	RFIN	This pin is AC coupled and matched to 50 Ohms.	
8 - 11	N/C	No Connection	
16	RFOUT	This pin is AC coupled and matched to 50 Ohms.	
23, 22, 21, 20	Vdd1, 2, 3, 4	Power Supply Voltage for the amplifier. External bypass capacitors of 100 pF, 10 nF and 4.7 μF are required.	

### Application Circuit



For price, delivery, and to place orders, please contact Hittite Microwave Corporation:  
 20 Alpha Road, Chelmsford, MA 01824 Phone: 978-250-3343 Fax: 978-250-3373  
 Order On-line at [www.hittite.com](http://www.hittite.com)

### Outline Drawing



NOTES:

1. LEADFRAME MATERIAL: COPPER ALLOY
2. DIMENSIONS ARE IN INCHES [MILLIMETERS]
3. LEAD SPACING TOLERANCE IS NON-CUMULATIVE
4. PAD BURR LENGTH SHALL BE 0.15mm MAXIMUM. PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM.
5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
7. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED LAND PATTERN.

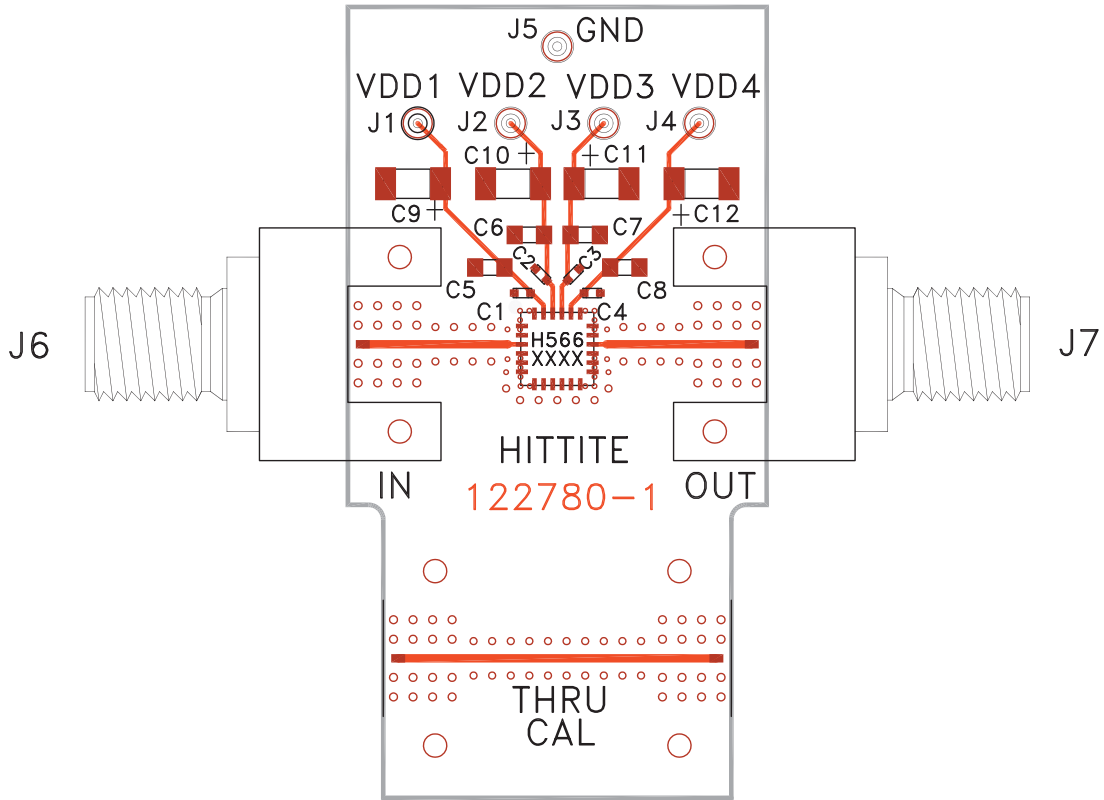
### Package Information

Part Number	Package Body Material	Lead Finish	Package Marking <sup>[1]</sup>
HMC566LP4E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn <sup>[2]</sup>	H566 XXXX

[1] 4-Digit lot number XXXX

[2] Max peak reflow temperature of 260 °C

### Evaluation PCB



### List of Materials for Evaluation PCB 122782 [1]

Item	Description
J1 - J5	DC Pin
J6 - J7	PCB Mount K Connector
C1 - C4	100 pF Capacitor, 0402 Pkg.
C5 - C8	10 nF Capacitor, 0603 Pkg.
C9 - C12	4.7 $\mu$ F Capacitor, Tantalum
U1	HMC566LP4E
PCB [2]	122780 Evaluation PCB

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350 or Arlon 25 FR

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and package bottom should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

**Телефон:** 8 (812) 309 58 32 (многоканальный)

**Факс:** 8 (812) 320-02-42

**Электронная почта:** [org@eplast1.ru](mailto:org@eplast1.ru)

**Адрес:** 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.